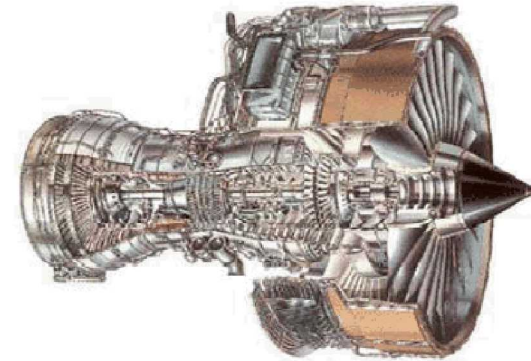
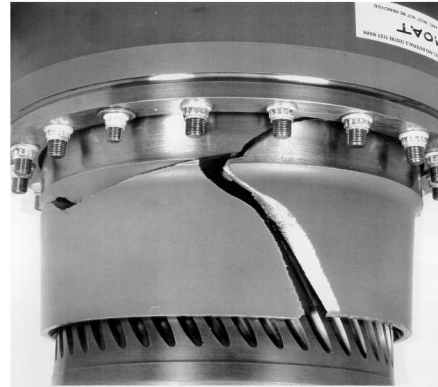
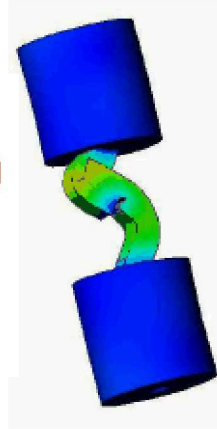


Exceptional service in the national interest

N=O=MAD
Research Institute



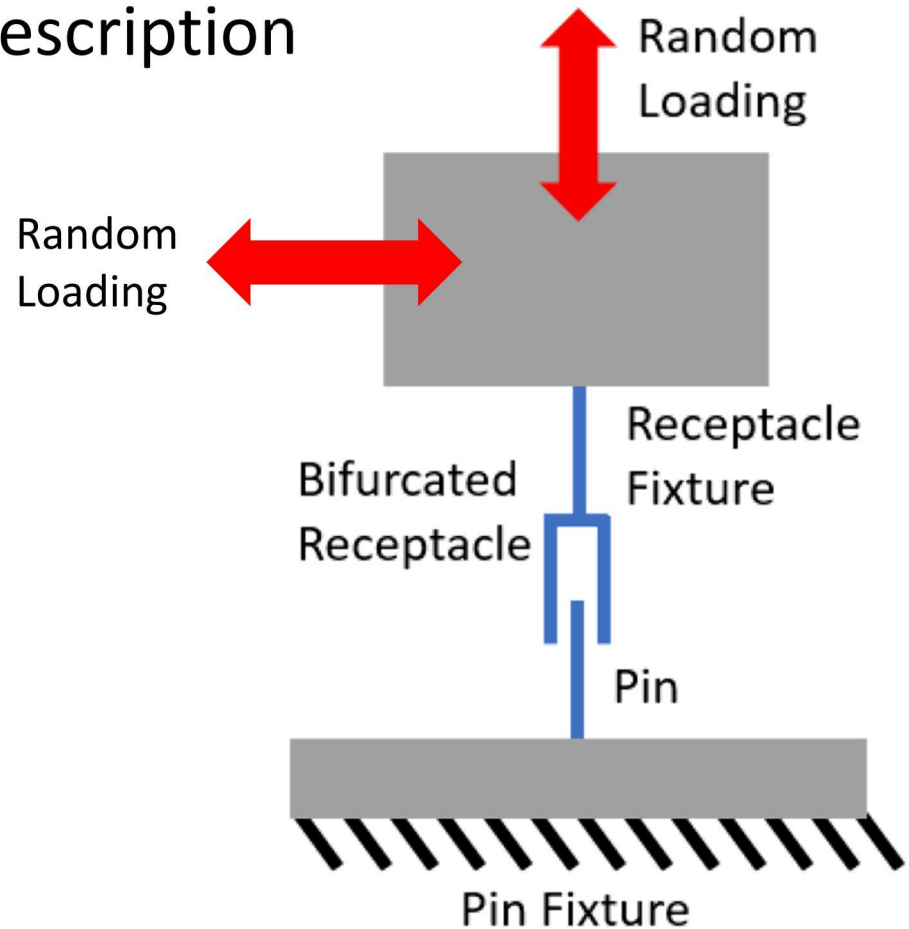
Investigation of Electrical Contact Chatter in Pin-Receptacle Contacts

Students: Brianna Johnson, Chris Schumann, and Fadi Rafeedi

Mentors: Rob Flicek, Kelsey Johnson, Karl Walczak,
Cory Medina, Dane Quinn, Benjamin Zastrow, Rob Kuether

Outline for Presentation

- Motivation & Project Description
- Modal Testing
- Chatter Testing
- Data Processing
- Closing Remarks

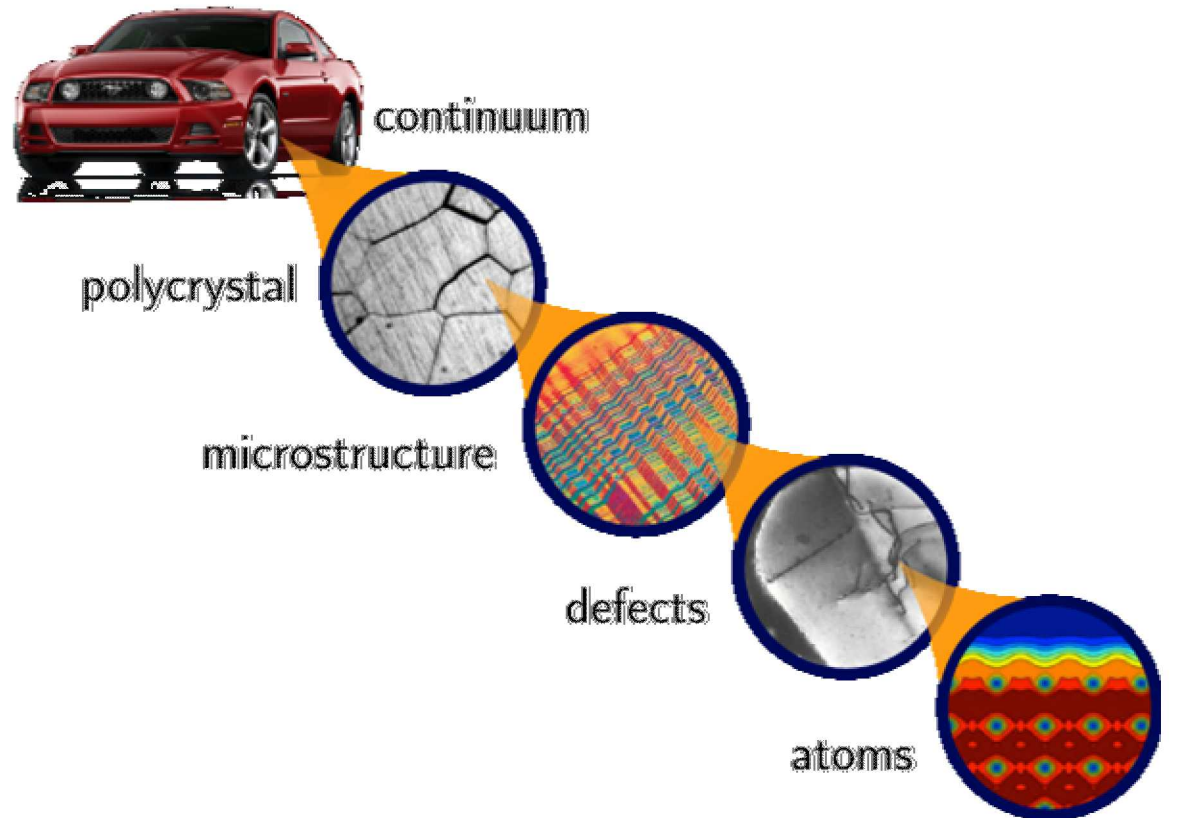


Motivation

- **Electrical contact chatter** refers to the sudden degradation of electrical current flow through a closed circuit
- Generally defined as the electrical resistance of the contact exceeding a threshold for a specified duration of time
 - 150 Ohms for 25 ns for our project
- Observed to occur when electrical contacts are subject to severe **random vibration environments**
- Previous experiments were system level, could not record inputs to pin and receptacle
- **What causes chatter?**
- **How can we predict chatter?**

Chatter is a Multiscale Physics Problem

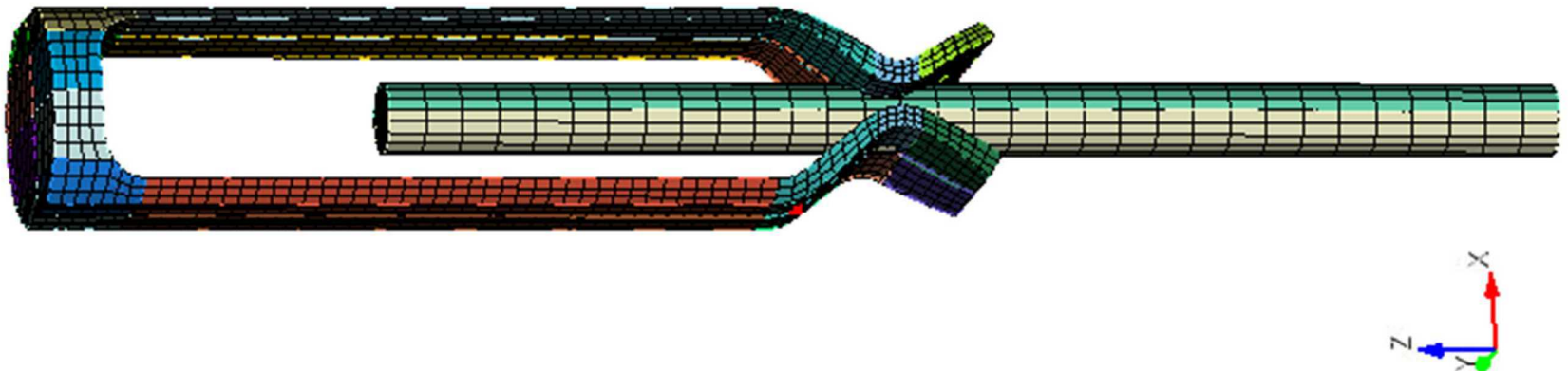
- Component (cm) to surface texture (nm)
- Short timescale (ns)
- Disciplines such as:
 - **Contact mechanics**
 - **Structural dynamics**
 - Tribology
 - Lubrication
 - Electrostatics
 - Etc.



<https://solids.uccs.edu/images/multiscale.png>

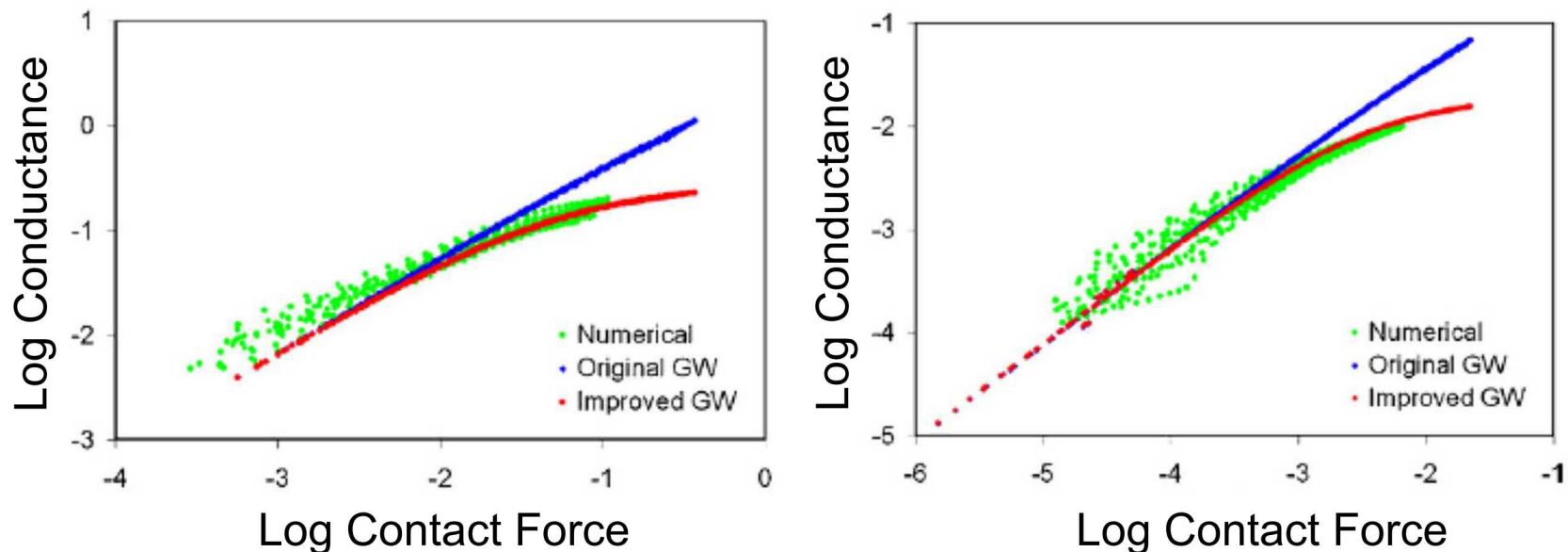
Computational Contradictions

- Detailed contact mechanics models are often **quasi-static**
- Chatter is a **high frequency dynamic** event
- Balance between critical timestep and a mesh fine enough to accurately capture contact



Contact Force to Contact Resistance

- Linear relationship between contact force and contact resistance (Ciavarella, et al., 2008)

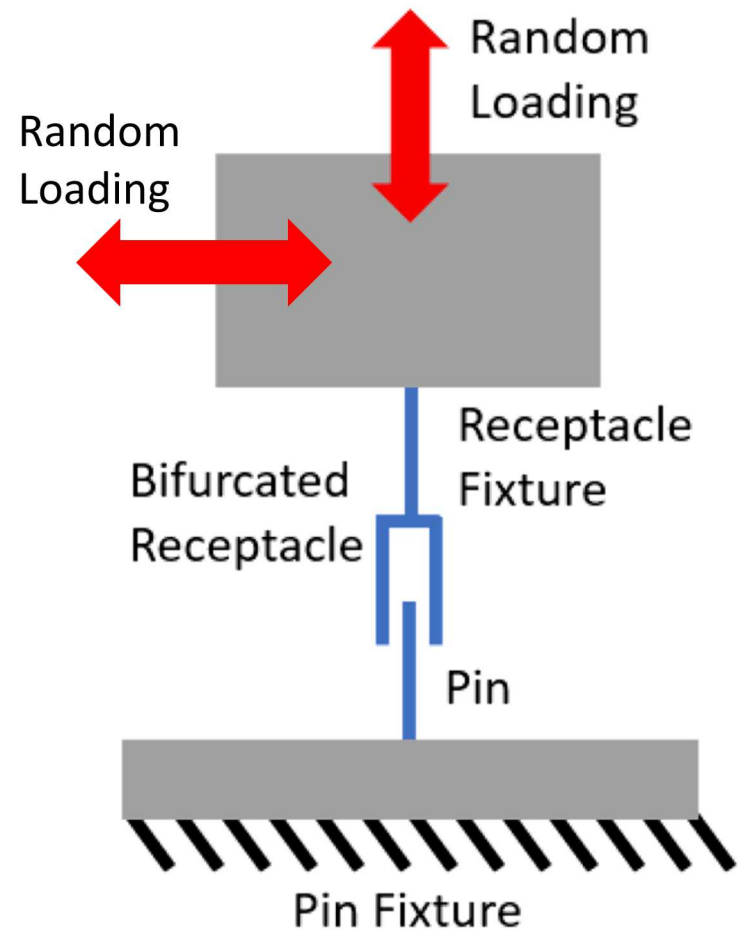


Ciavarella, et al., Inclusion of "interaction" in the Greenwood and Williamson contact theory 2008

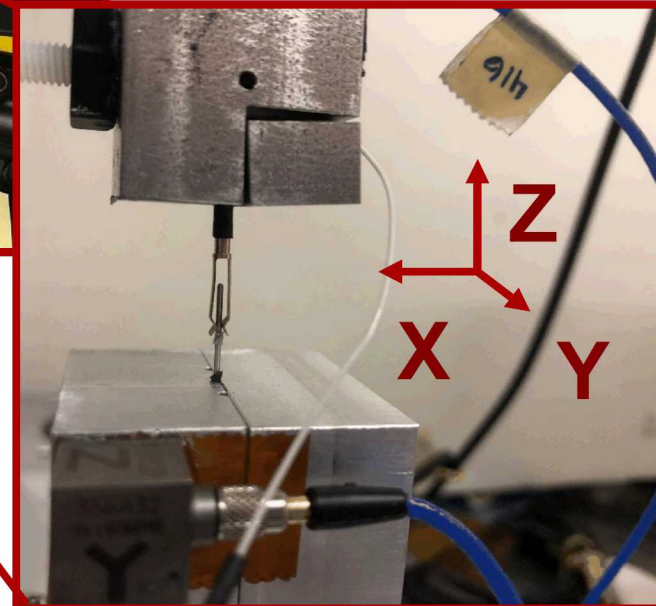
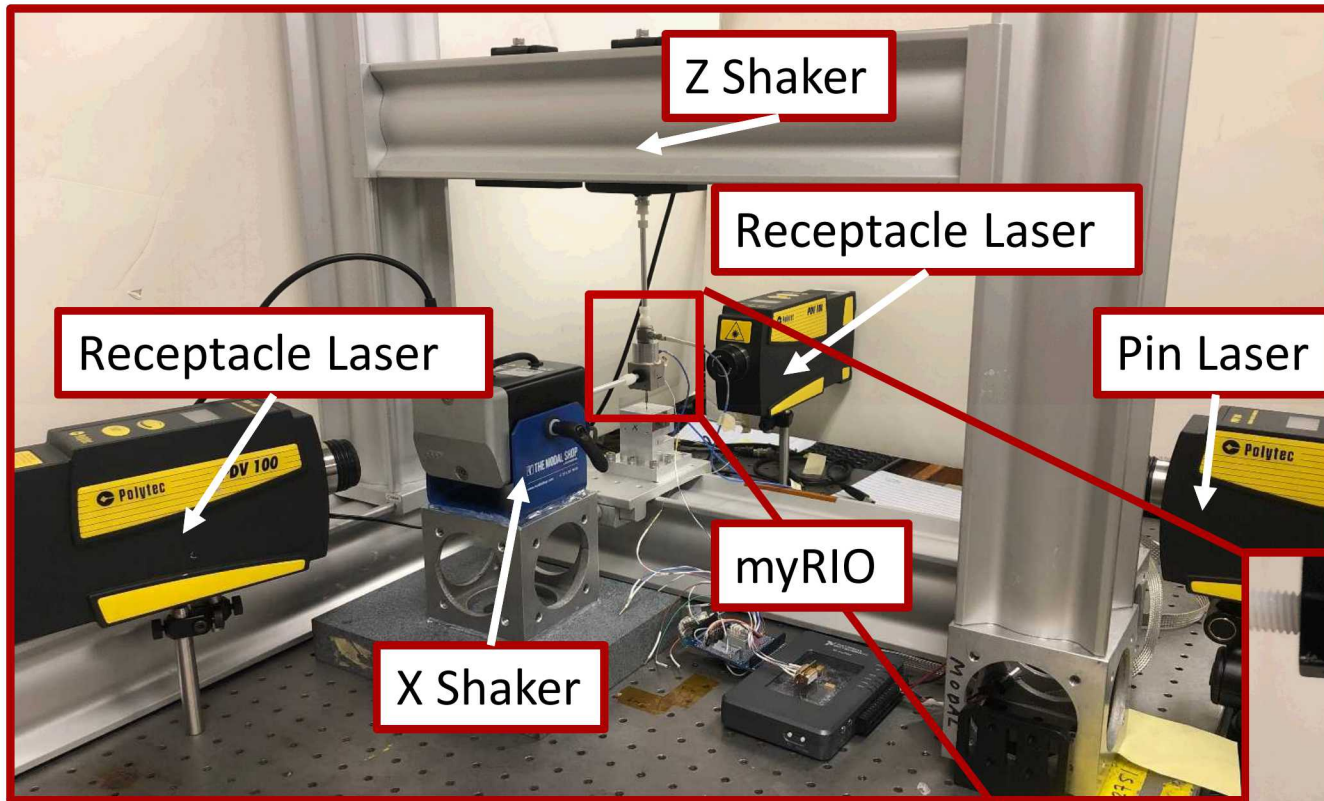
- Use contact force as a metric of chatter to correlate events between test and FEM

Project Objectives

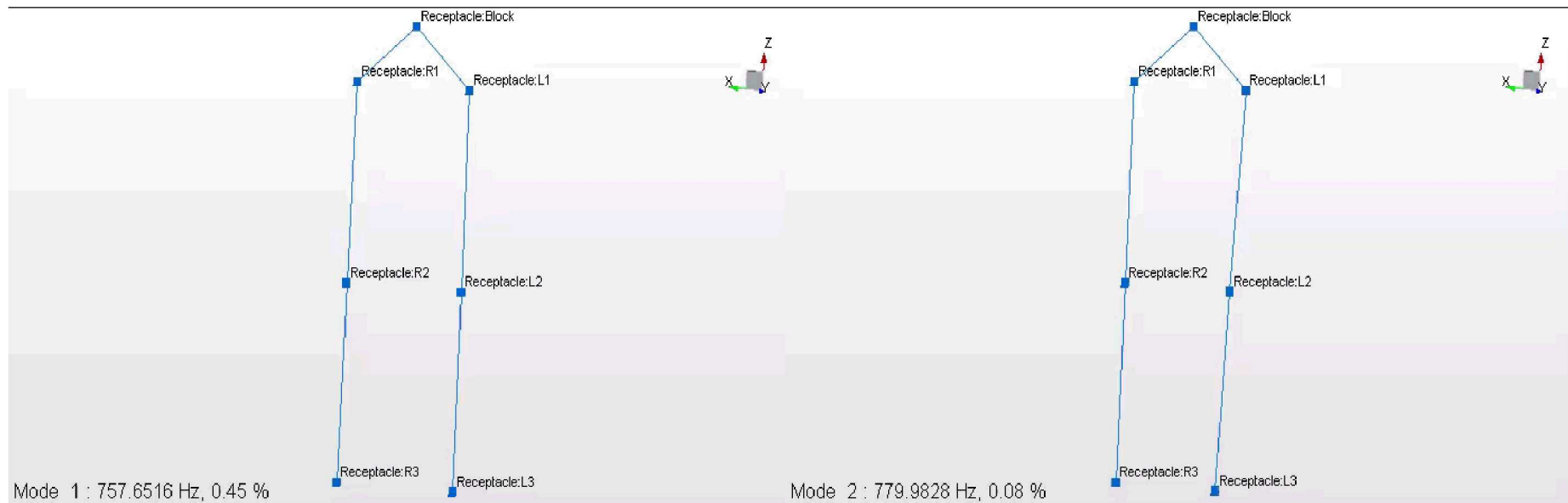
- **Goal: To perform a fundamental investigation of the physics governing chatter using a single electrical circuit with contact between a pin and a bifurcated receptacle**
- **Tasks**
 - Modal tests of parts and assembly
 - Record chatter from random vibration environments
 - Create FEM to simulate test results
 - Study relationship between system inputs and chatter



Test Setup - Mechanical



Modal Testing

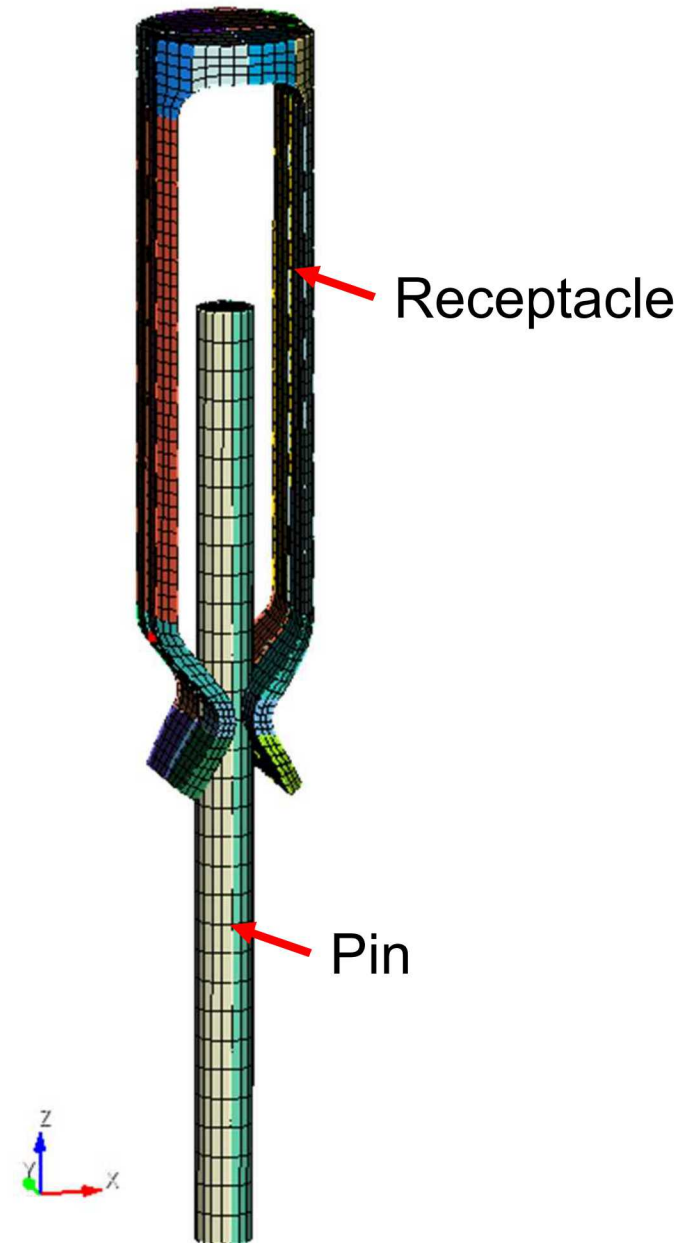


Mode 1: 758 Hz

Mode 2: 780 Hz

Finite Element Model

- Geometry
 - Pin: created in cubit, simple shape
 - Receptacle: uploaded from manufacturer file
- Mesh:
 - Low element count (5k) to reduce runtime
 - Coarse pin model to reduce artificial chatter

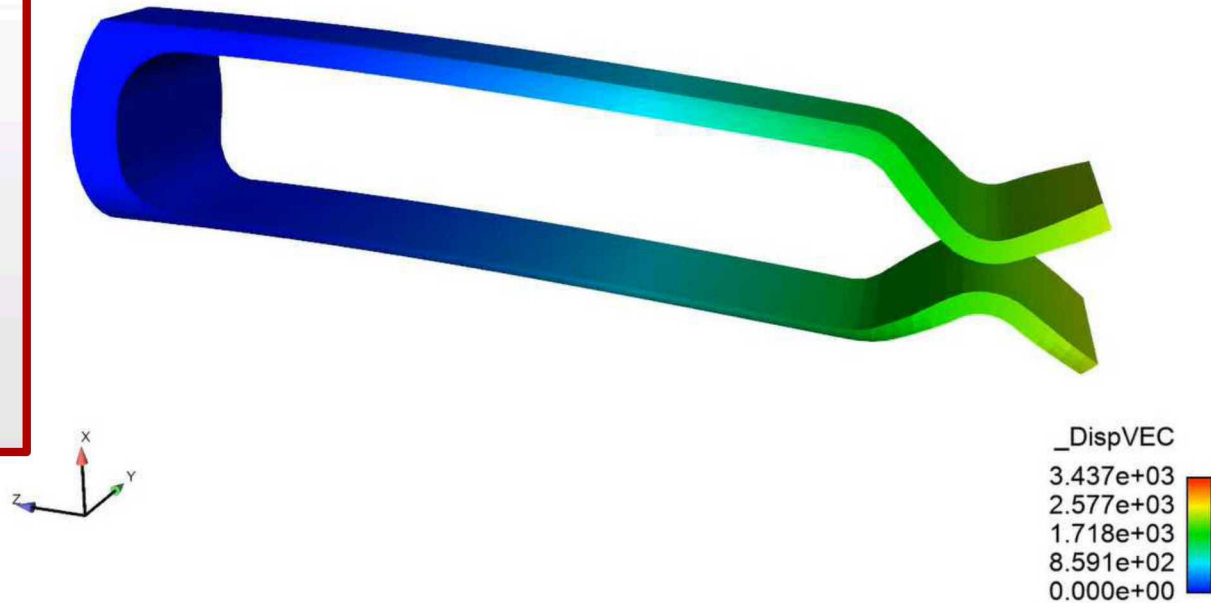
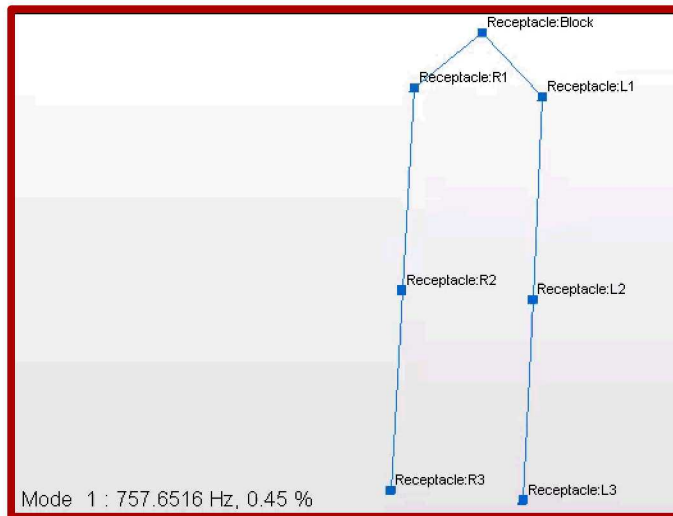


Receptacle Updating



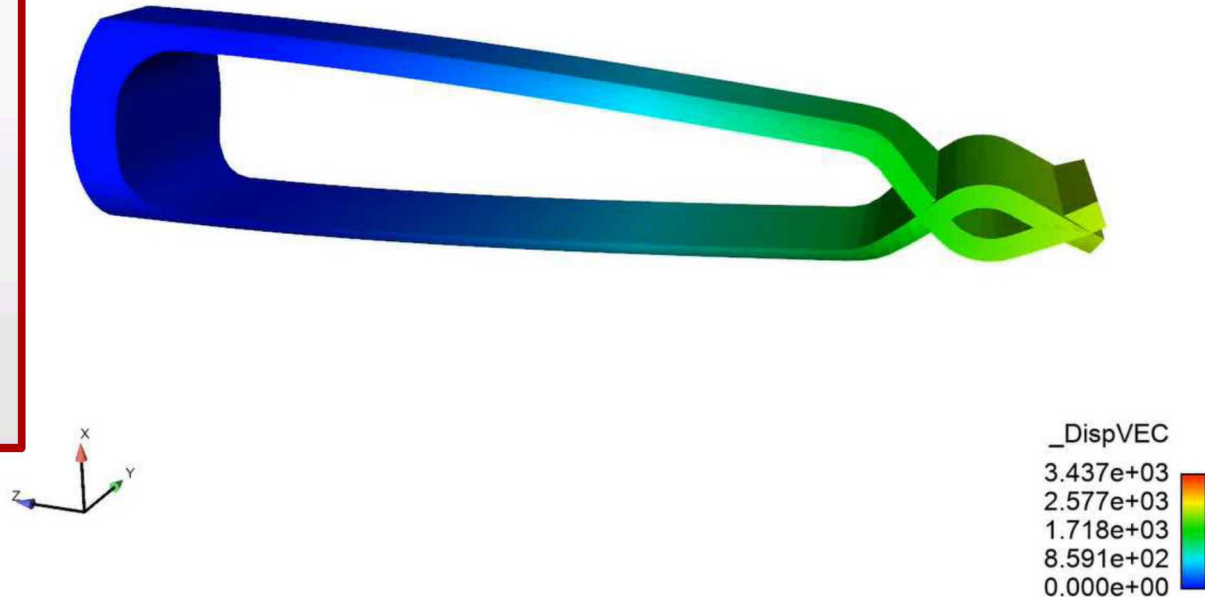
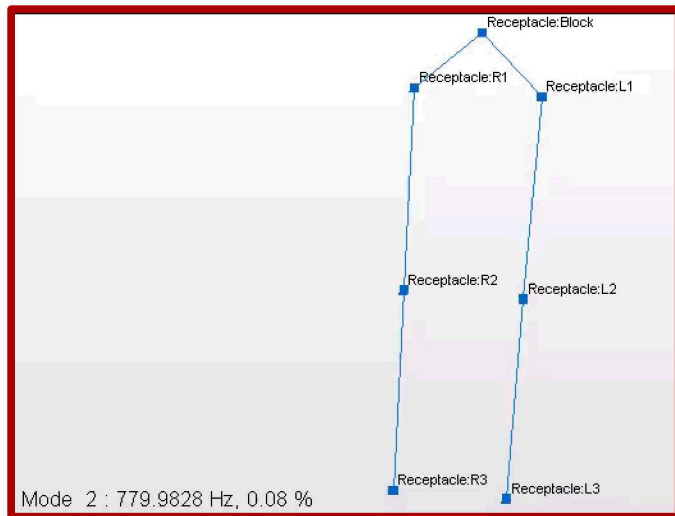
Receptacle Mode 1

Mode Description	Experimental Frequency [Hz]	Updated FEM Frequency [Hz]	% Error
In-phase 1 st bending mode	757.7	770.3	1.66%

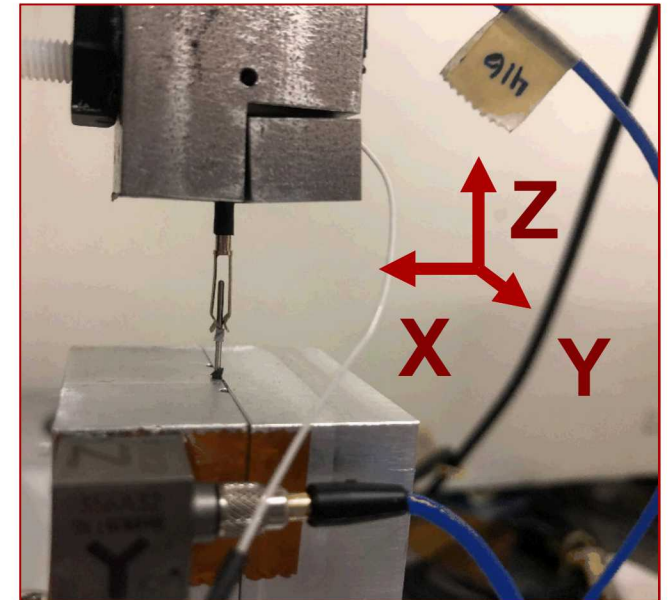
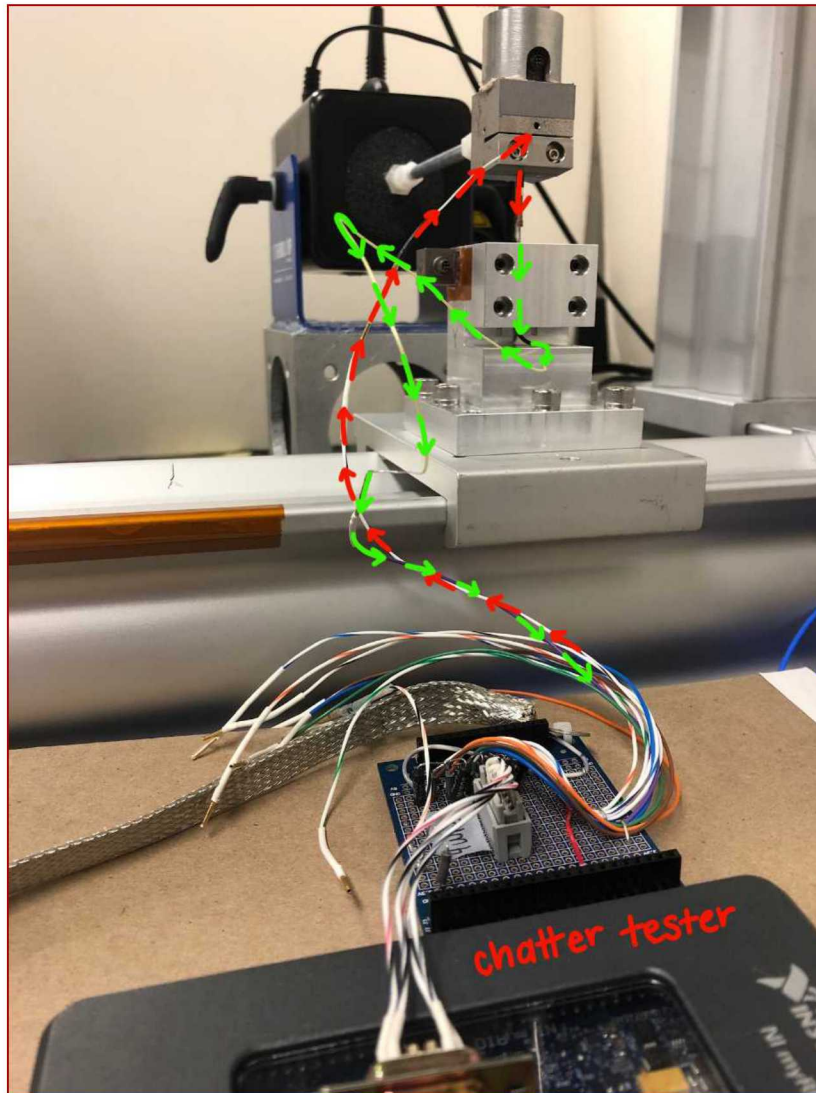


Receptacle Mode 2

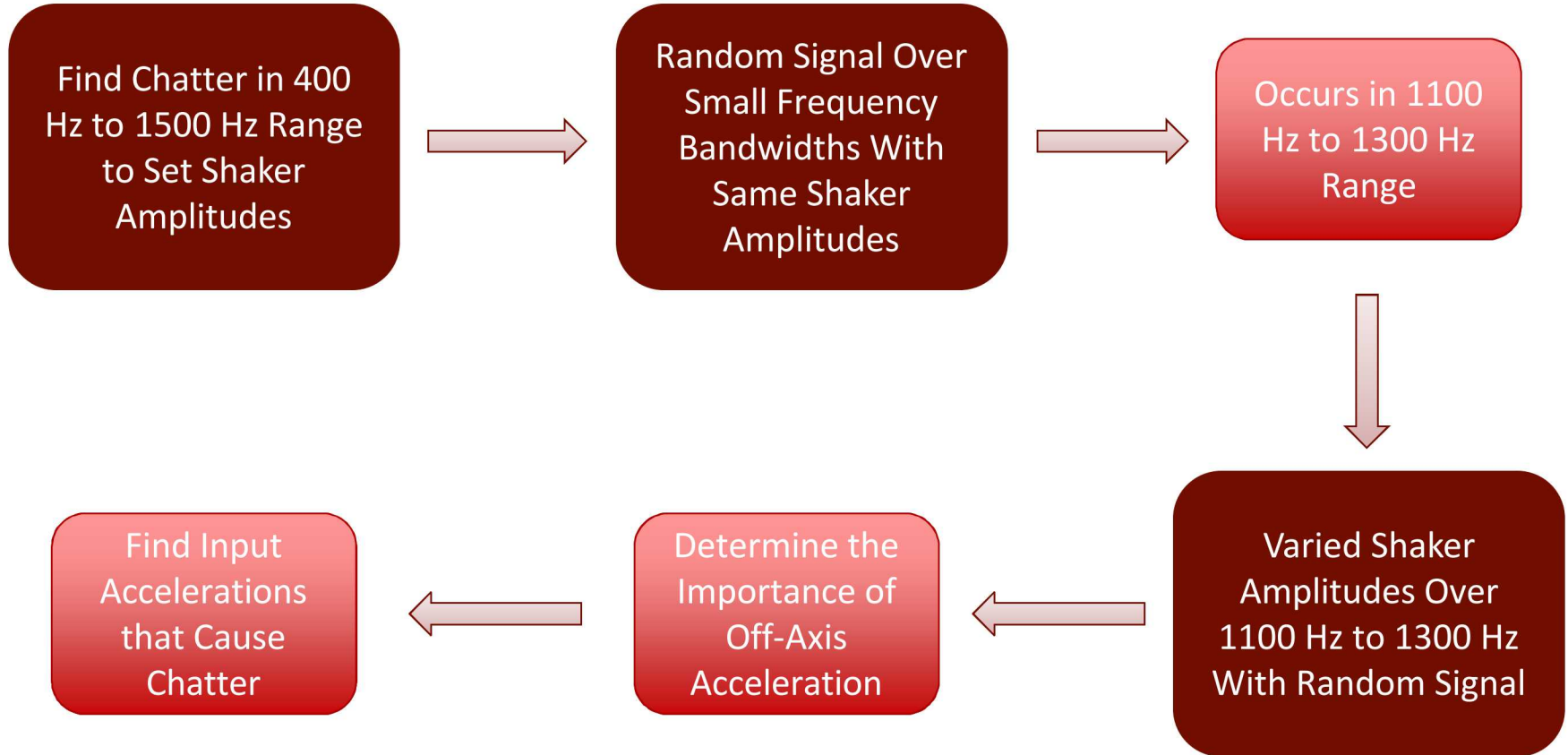
Mode Description	Experimental Frequency [Hz]	Updated FEM Frequency [Hz]	% Error
Out-of-phase 1 st bending mode	780.0	770.4	-1.24%



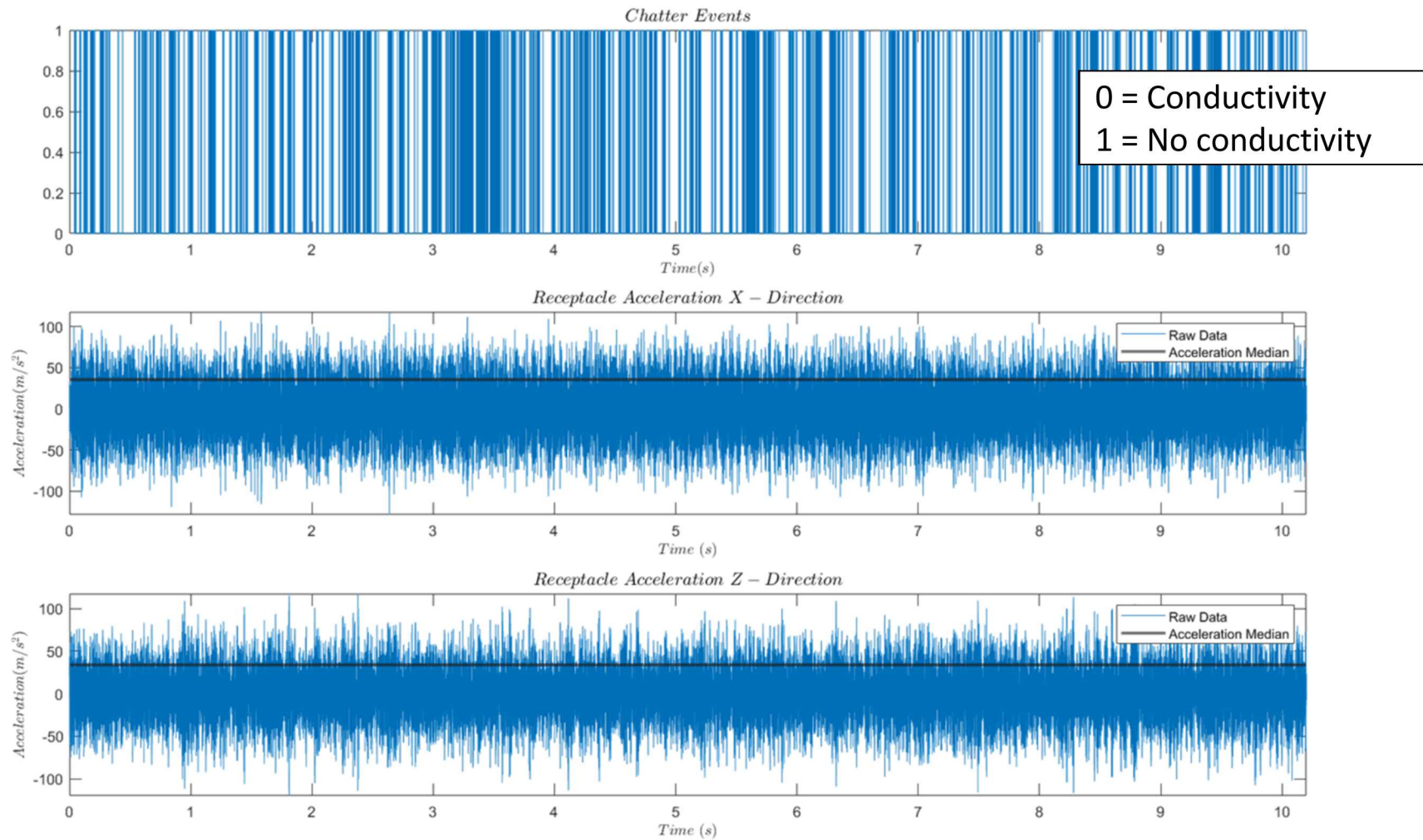
Test Setup - Electrical



Chatter Test Experimental Design



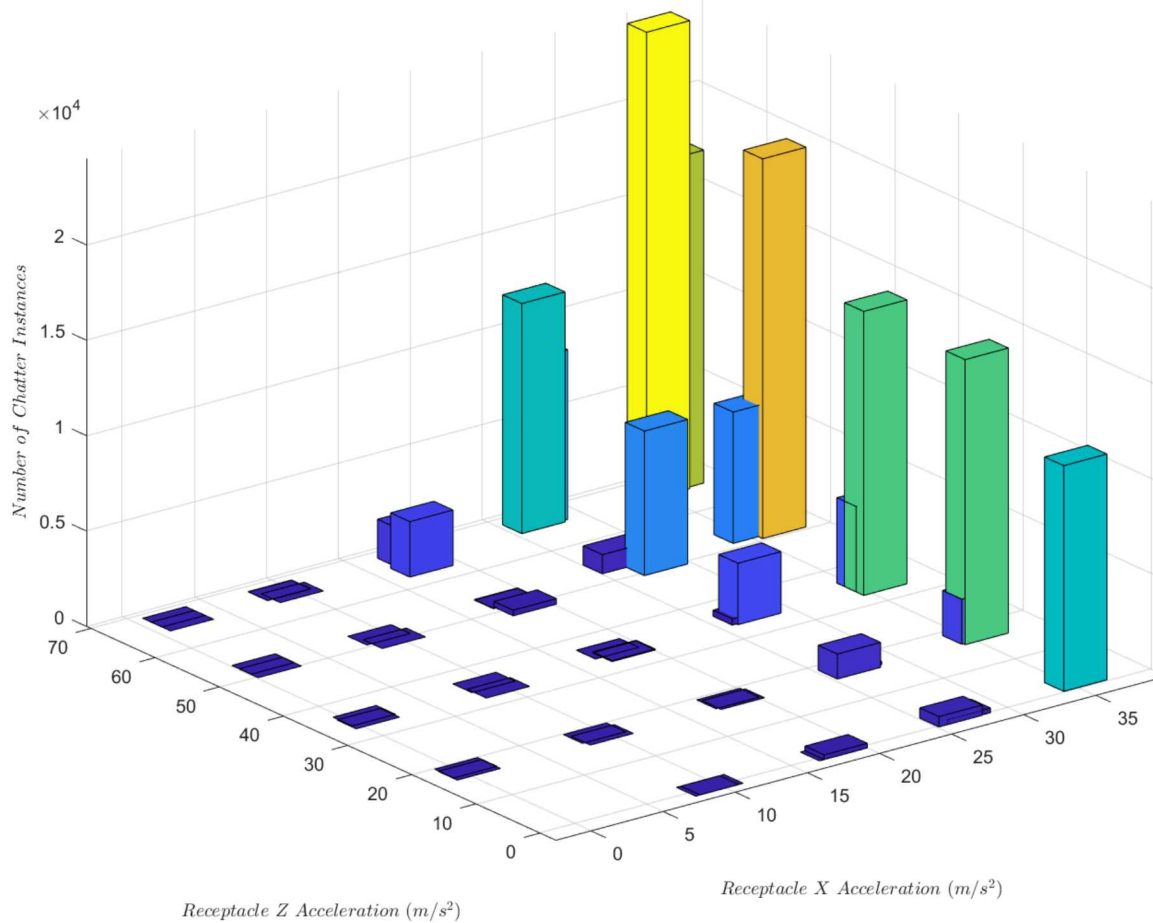
Raw Test Data



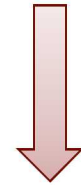
Analysis Across Multiple Runs

Combination of Accelerations for Chatter

Number of Chatter Instances Versus Receptacle Acceleration

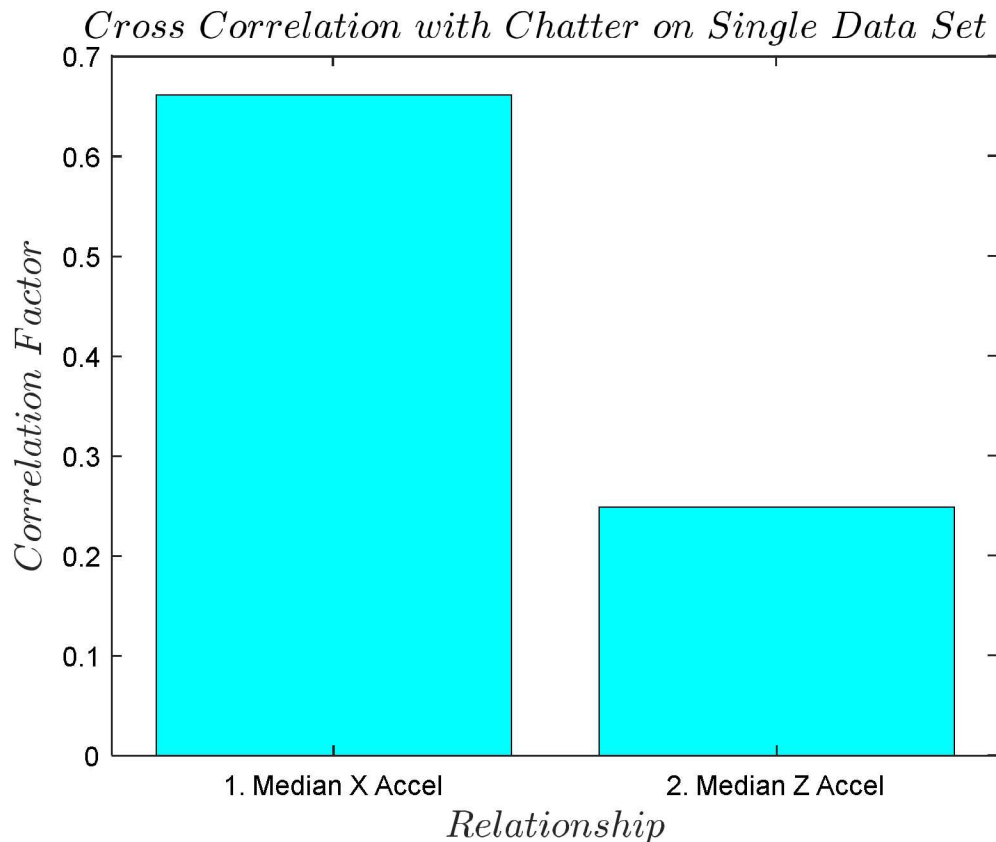


Chatter requires
Off-Axis
Excitation to
occur



The most chatter
occurs with
maximum X and
Z Acceleration

Correlation of Accelerations to Chatter Across Multiple Data Sets

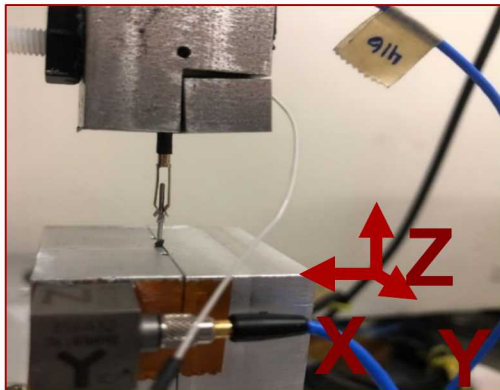
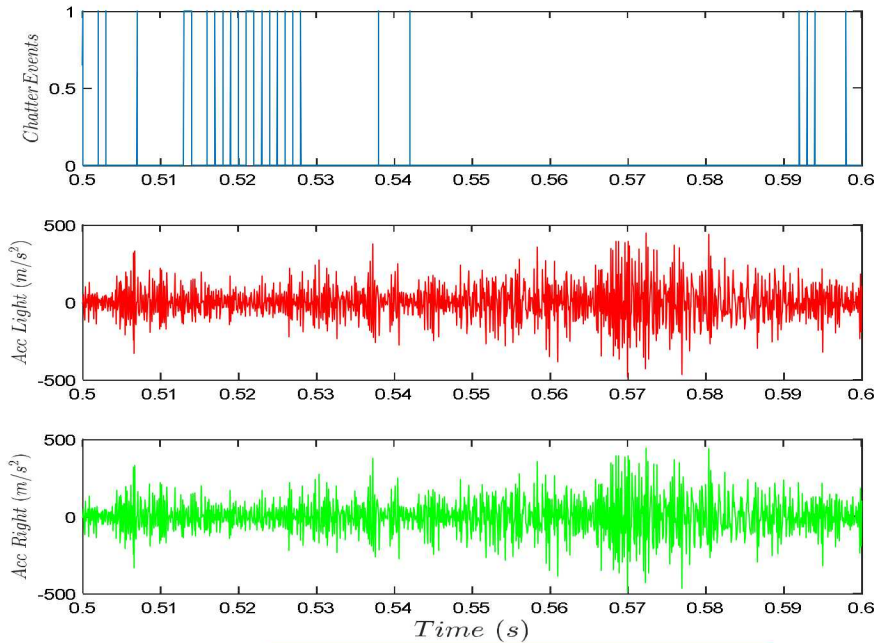


- Cross correlation between chatter and multiple variables was calculated.
- This compares which variables correlate to chatter more.

Analysis Across Single Sets

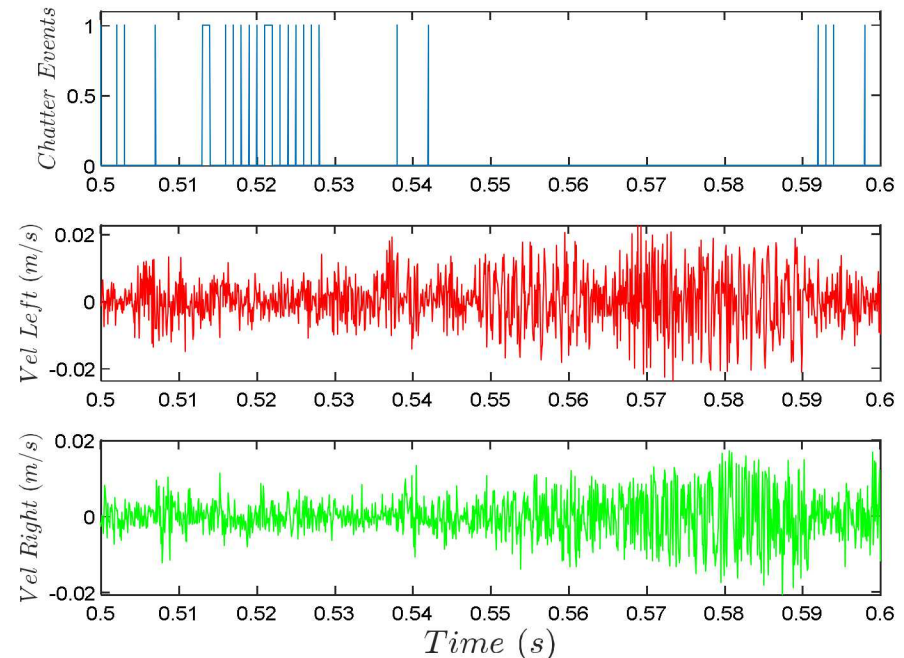
Acceleration and Velocity of Receptacle Legs (Outputs)

Acceleration of Receptacle Legs and Chatter



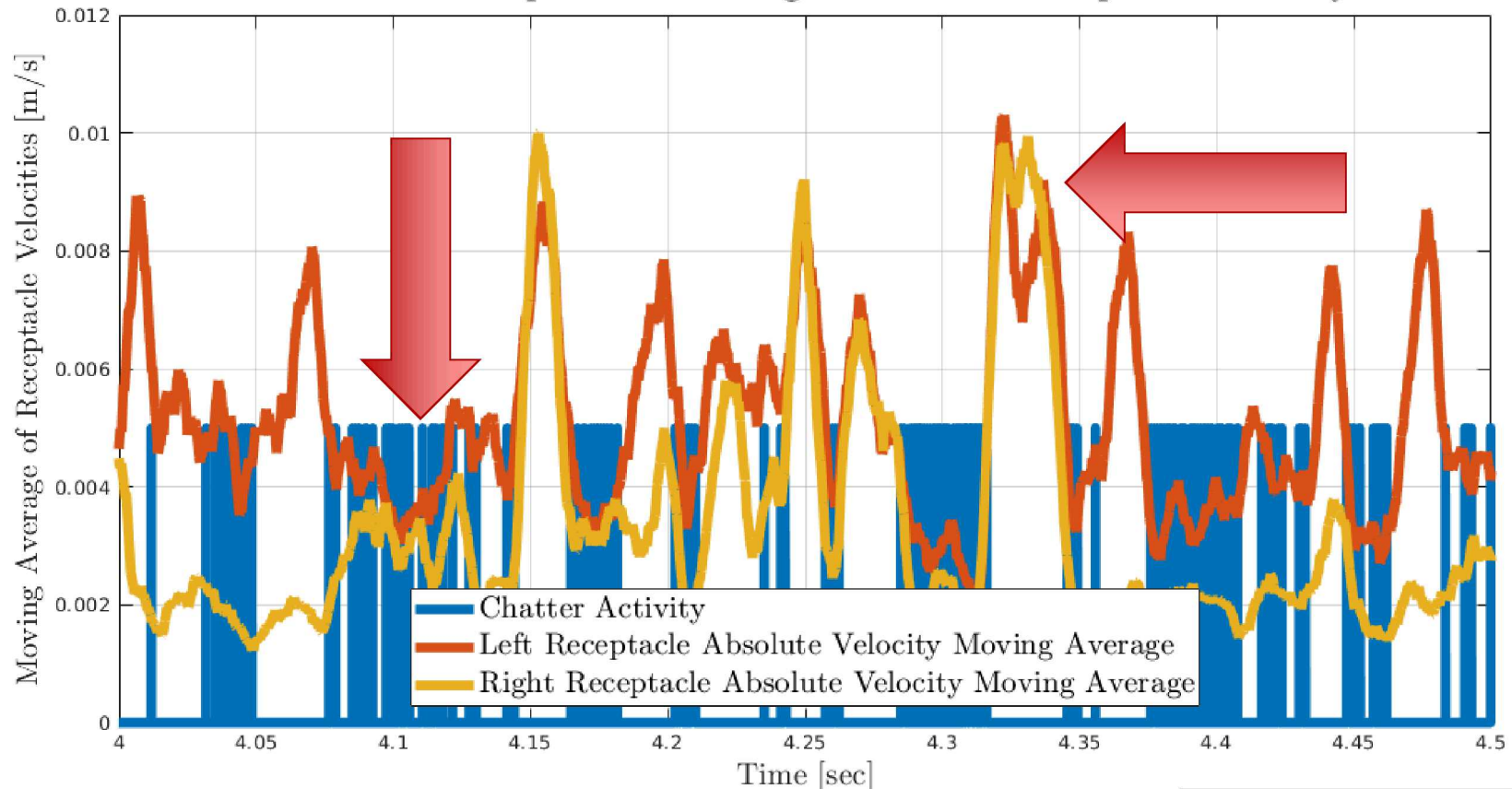
0 = Conductivity
1 = No conductivity

Velocity of Receptacle Legs and Chatter



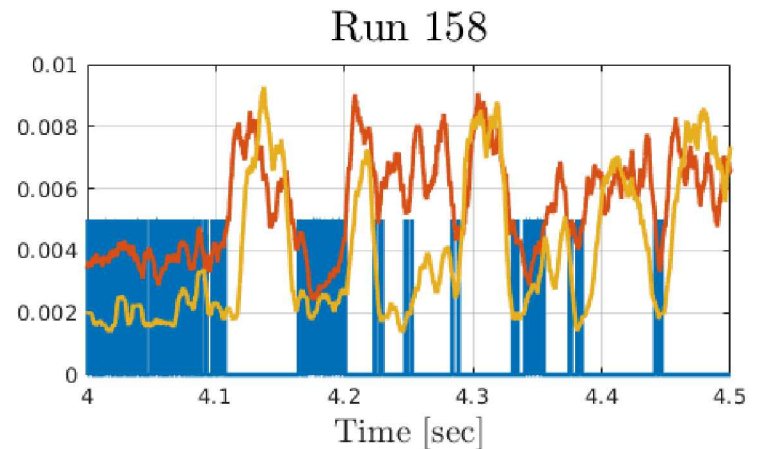
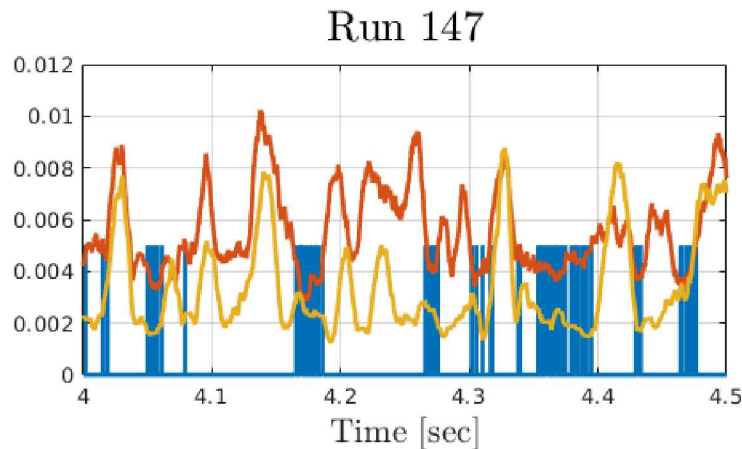
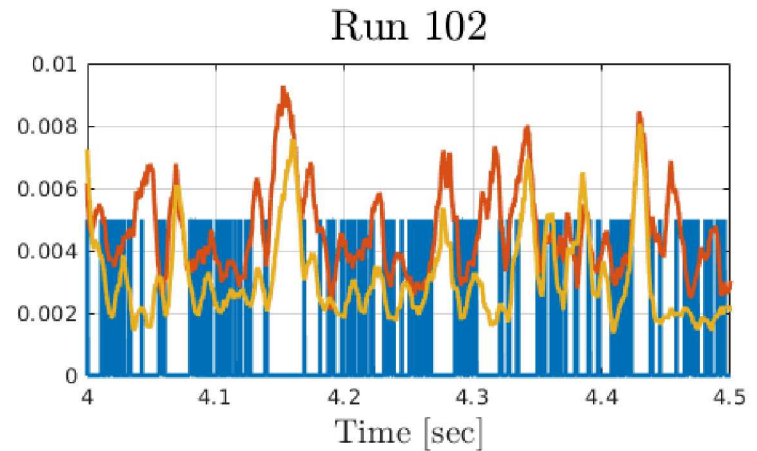
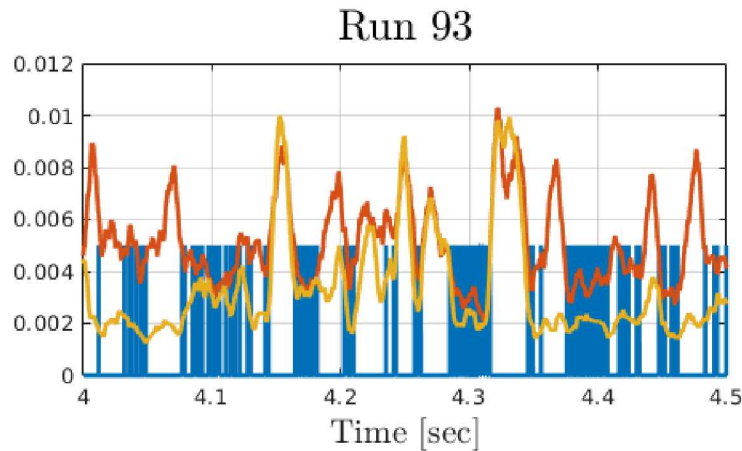
Receptacle Velocity to Chatter

Chatter Occurances Compared to Averaged Absolute Receptacle Velocity vs. Time



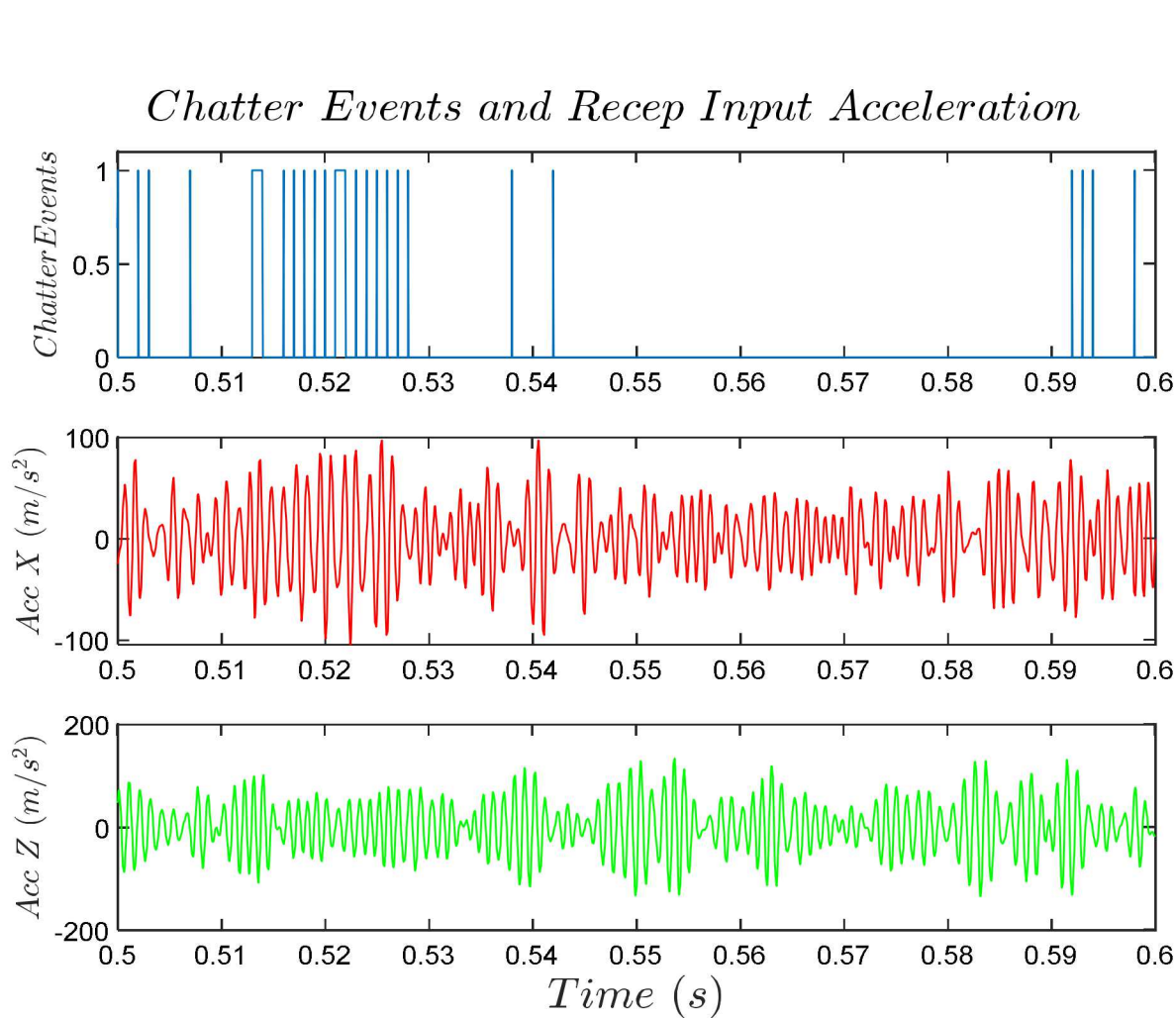
0.0 = Conductivity
0.005 = No conductivity

Receptacle Velocity to Chatter

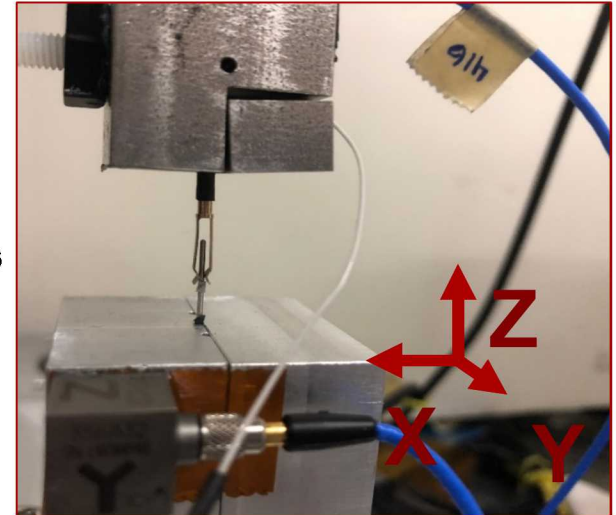


0.0 = Conductivity
0.005 = No conductivity

Input Acceleration and Chatter

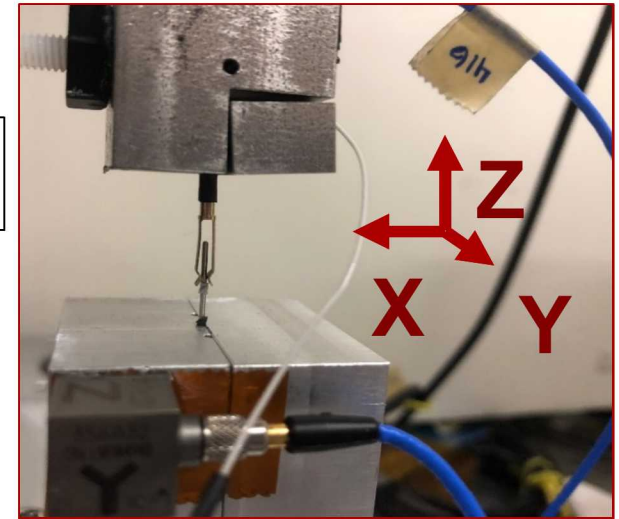
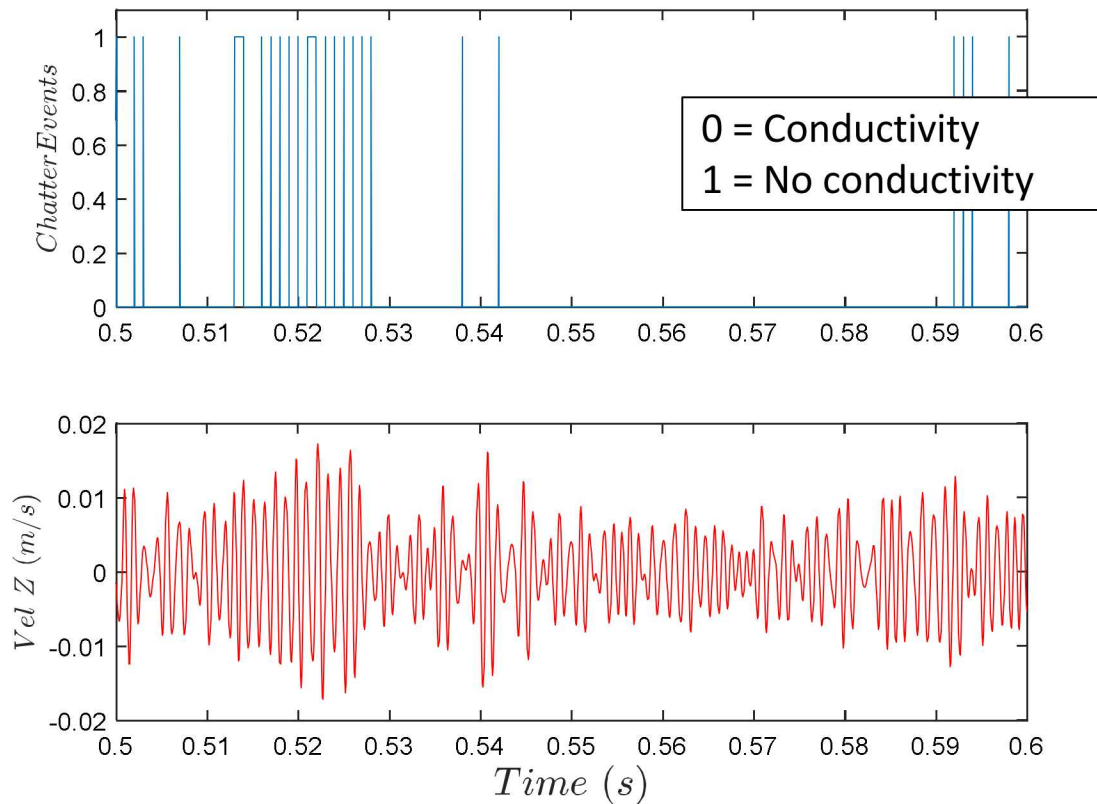


0 = Conductivity
1 = No conductivity

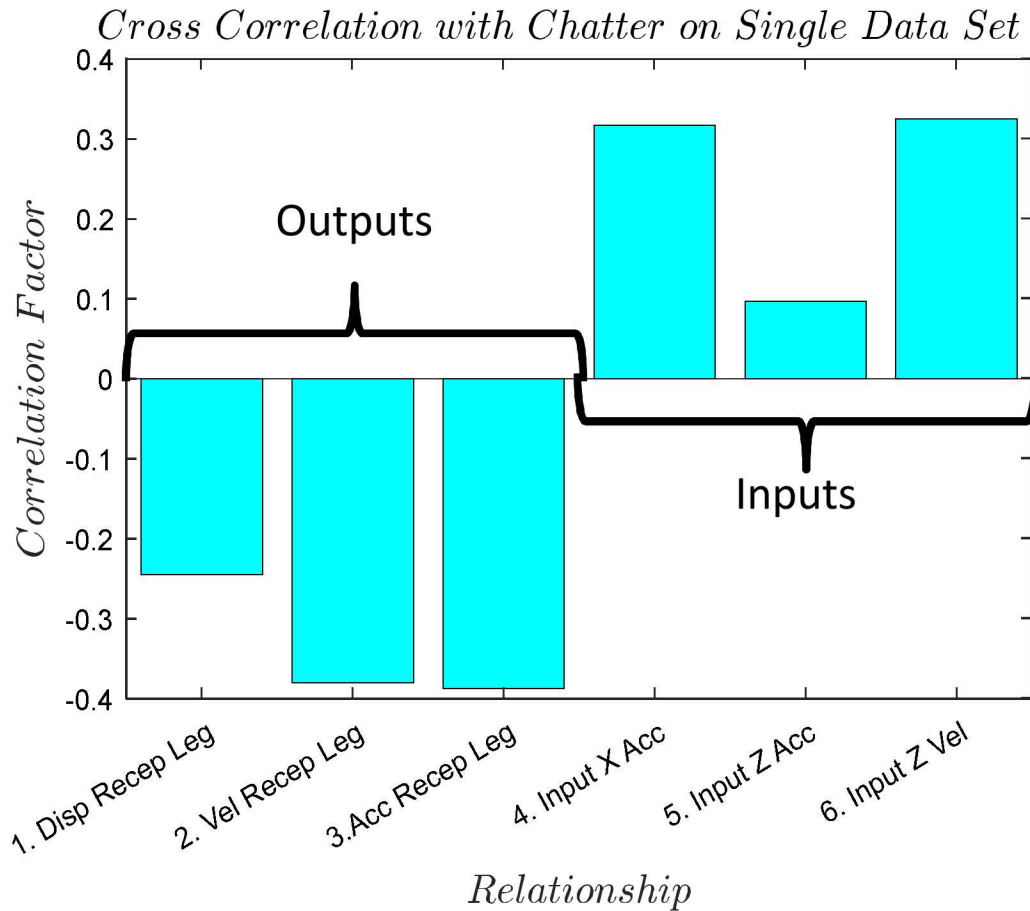


Receptacle Z Input Velocity

Receptacle Z Velocity and Chatter



Correlation Across a Single Set



- Cross correlation between chatter and multiple variables was calculated.
- This compares which variables correlate to chatter more.

SM Analysis Results

Introduction

Motivation

Modal

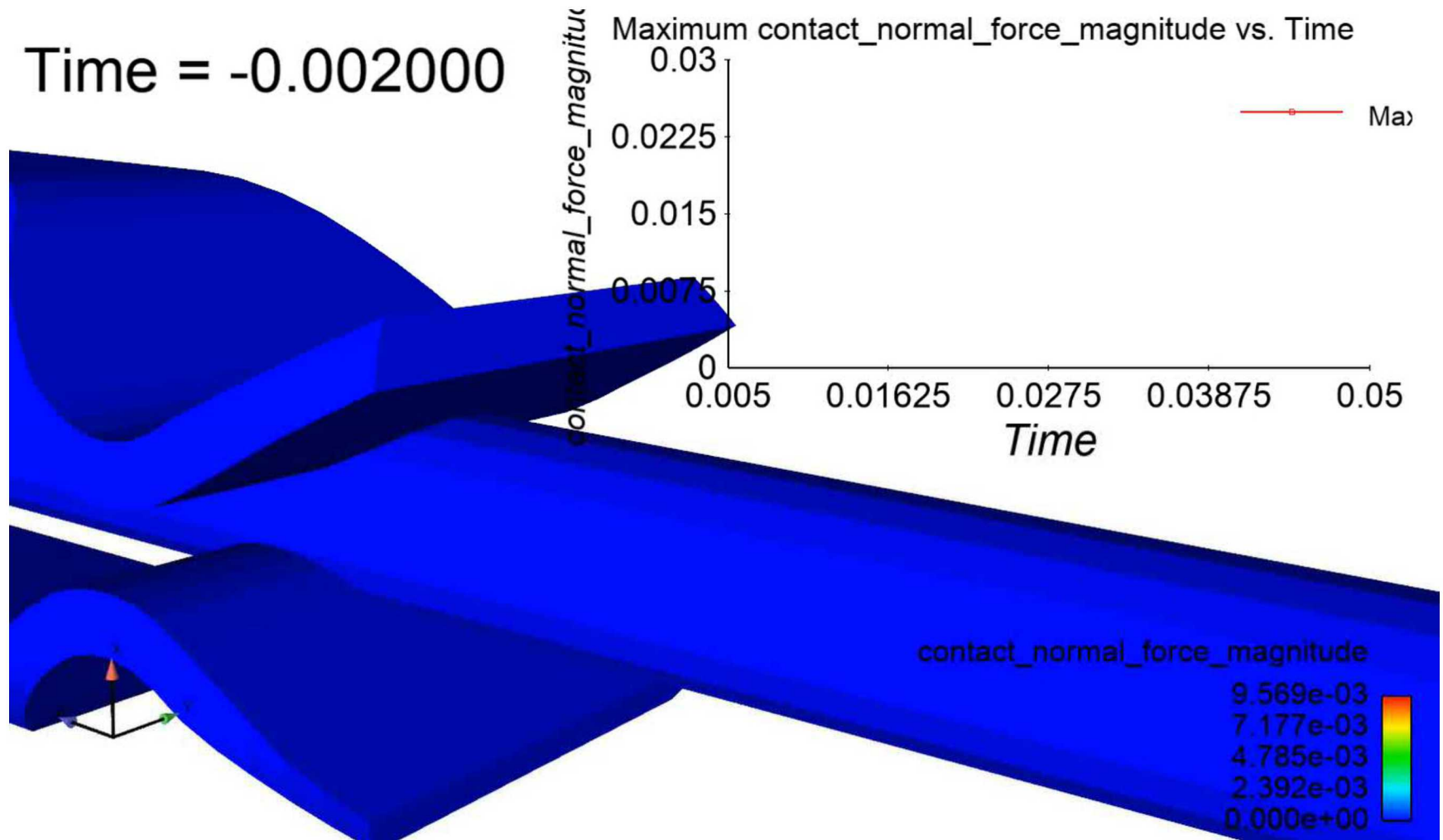
Chatter

Data

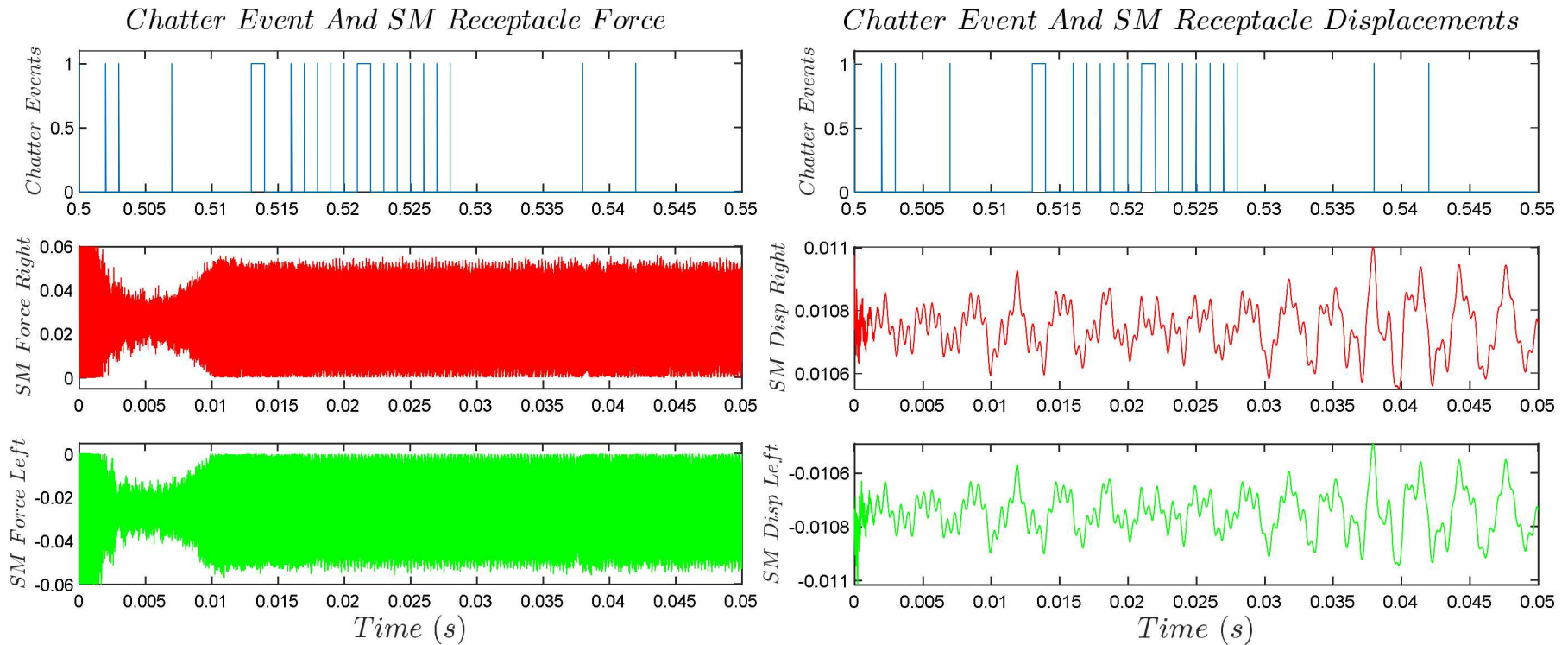
Conclusion

SM Response to Experimental Inputs

Time = -0.002000



SM Receptacle Displacement to Chatter



Challenges and Limitations

- Lasers
 - Did not use reflective tape in order to keep accurate system dynamics
 - Time delay between laser data and accelerometer
- Chatter Tester
 - LMS channels sample at 204.8 kHz per channel
 - Chatter Tester samples at 40 MHz
- System Mode around 1300 Hz
 - Appeared to be the same area where chatter occurred most
- Same Inputs – Different Results

Closing Remarks

- Ran the first chatter test to obtain acceleration inputs to pin and receptacle
- Created explicit dynamic and linear transient models of pin and receptacle that can use accelerometer data as inputs to simulate test
- Found a high correlation between off-axis motion and chatter occurrence over multiple runs
- Continued work is being done to process data and correlate FEM model to test data

Acknowledgements

- This research was conducted at the 2019 Nonlinear Mechanics and Dynamics Research Institute supported by Sandia National Laboratories and hosted by the University of New Mexico.
- Sandia National Laboratories is a multimission laboratory managed and operated by National Technology and Engineering Solutions of Sandia, LLC., a wholly owned subsidiary of Honeywell International, Inc., for the U.S. Department of Energy's National Nuclear Security Administration under contract DE-NA-0003525.